

PTO-1449			Attorney's Docket Number 135140-2	Serial Number 10/803,694		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT <u>LIST OF ITEMS</u>			Name of Applicant Sanjay Gurbasappa Charati			
(Use several sheets if necessary)			Filing Date 03/18/2004	Group Art Unit 1711		
U.S. PATENT DOCUMENTS						
Examiner Initial	Document Number	Date	NAME	Class	Subclass	Filing Date If Appropriate
<i>PB</i>	1. US 6,384,128	05/07/2002	Wadahara et al.	1	—	
<i>PB</i>	2. US 6,673,864 B2	01/06/2004	Patel et al.	—	—	
<i>PB</i>	3. US 2002/0099128 A1	07/25/2002	Patel et al.	—	—	
				—	—	
				—	—	
FOREIGN PATENT DOCUMENTS						
Examiner Initial	Document Number	Date	COUNTRY	Class	Subclass	Translation YES NO
<i>PB</i>	4. WO 2004/001107 A2	31.12.03	PCT	—	—	NO
OTHER INFORMATION (including author, title, date, pertinent)						
5.	Japanese Patent Office and Derwent Abstract for JP 2002365427 A2 Publication date 18.12.02					
6.	Harry J. Barraza et al. "SWNT-Filled Thermoplastic and Elastomeric Composites Prepared by Miniemulsion Polymerization" NANO Letters, August 2002, Vol. 2, Number 8, pp. 797-802.					
7.	Cheol Park et al. "Dispersion of single wall carbon nanotubes by in situ polymerization under sonication" Chemical Physics Letters 364 (2002) pp. 303-308, 4 October 2002.,					
8.	A. Dufresne et al. "Processing and characterization of carbon nanotube/poly(styrene-co-butyl acrylate) nanocomposites" Journal Of Materials Science 37 (2002) pp.3915-3923					
9.	Application Serial Number 11/057,946; filed 02-15-2005, Jan Peter Keulen et al., ELECTRICALLY CONDUCTIVE COMPOSITIONS AND METHOD OF MANUFACTURE THEREOF (Available in IFW)					
10.	International Search Report PCT/US2004/020082 International Filing Date 22/06/2004					
11.	International Search Report PCT/US 2004/026136 International Filing Date 12/08/2004					
EXAMINER <i>James Boykin</i>			DATE CONSIDERED <i>8/25/05</i>			
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U.S. PATENT DOCUMENTS						
Examiner Initial	Document Number	Date	NAME	Class	Subclass	Filing Date If Appropriate
<i>RB</i>	US 2003/038279 A1	02/27/2003	Ishioka et al.			
<i>RB</i>	US 2002/0183438 A1	12/05/2002	Amarasekera et al.			
FOREIGN PATENT DOCUMENTS						
Examiner Initial	Document Number	Date	COUNTRY	Class	Subclass	TRANSLATION YES NO
<i>RB</i>	WO 01/95344 A1	13.12.2001	PCT			NO
<i>RB</i>	WO 03/024798 A1	27.03.2003	PCT			NO
	WO 03/080513 A2	02.10.2003	PCT			NO
	WO 2004/059663 A1	15.07.2004	PCT			NO
	EP 1 052 654 B1	28.01.2004	European			NO
	EP 1 369 452 A1	10.12.2003	European			NO
<i>RB</i>	EP 1 460 703 A1	22.09.2004	European			NO
OTHER INFORMATION (including author, title, date, pertinent)						
<i>RB</i>	International Search Report PCT/US 2004/012109 International Filing Date 20/04/2004					
<i>RB</i>	International Search Report PCT/US 2004/025651 International Filing Date 06/08/2004					
	International Search Report PCT/US 2004/030864 International Filing Date 21/09/2004					
	International Search Report PCT/US 2004/031061 International Filing Date 22/09/2004					
	Application Serial Number 11/057946, Filed February 15, 2005, Keulen et al., ELECTRICALLY CONDUCTIVE COMPOSITIONS AND METHOD OF MANUFACTURE THEREOF (Copy enclosed)					
<i>RB</i>	Japanese Abstract for JP 02-077442 Publication date 16.03.1990					
EXAMINER	<i>Miranda Berklin</i>			DATE CONSIDERED <i>8/25/05</i>		
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